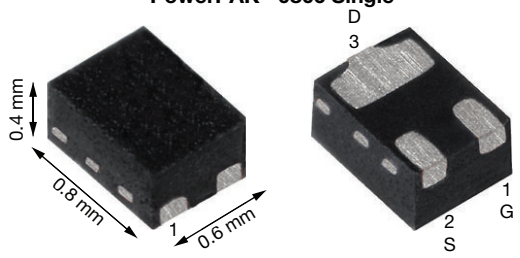
P-Channel 20 V (D-S) MOSFET

PowerPAK® 0806 Single



Top View | Bottom View

FEATURES

- TrenchFET® Gen III p-channel power MOSFET
- Ultra small 0.8 mm x 0.6 mm outline
- Ultra thin 0.4 mm max. height
- Typical ESD protection 1500 V (HBM)
- -1.5 V rated $R_{DS(on)}$
- 100% R_g tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free

RoHS COMPLIANT

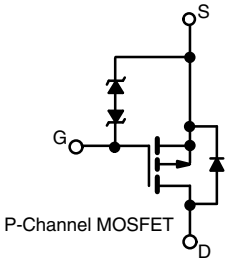
HALOGEN FREE

PRODUCT SUMMARY

V_{DS} (V)	-20
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	1.25
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	1.7
$R_{DS(on)}$ max. (Ω) at V_{GS} = -1.8 V	2.7
$R_{DS(on)}$ max. (Ω) at V_{GS} = -1.5 V	4.4
Q_g typ. (nC)	0.64
I_D (A)	-0.5 [a, f]
Configuration	Single

APPLICATIONS

- Load switch
- High speed switching
- Power management in battery-operated, mobile and wearable devices



P-Channel MOSFET

ORDERING INFORMATION

Package	PowerPAK 0806
Lead (Pb)-free and halogen-free	SiUD403ED-T1-GE3

Note

- The lead finish is NiPdAu and classed as E4 finish

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	-20	V
Gate-source voltage		V_{GS}	± 8	
Continuous drain current (T_J = 150 °C)	T_A = 25 °C	I_D	-0.5 [a, f]	A
	T_A = 70 °C		-0.5 [a, f]	
	T_A =25 °C		-0.4 [b]	
	T_A = 70 °C		-0.32 [b]	
Pulsed drain current (t = 100 µs)		I_{DM}	-0.8	
Continuous source-drain diode current	T_A = 25 °C	I_S	-0.5 [a, f]	
	T_A = 70 °C		-0.37 [b]	
Maximum power dissipation	T_A = 25 °C	P_D	1.25 [a]	W
	T_A = 70 °C		0.8 [a]	
	T_A = 25 °C		0.37 [b]	
	T_A = 70 °C		0.24 [b]	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) [c]			260	

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient [a, d]	t ≤ 5 s	R_{thJA}	80	100	°C/W
Maximum junction-to-ambient [b, e]			265	335	

Notes

a. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s
b. Surface mounted on 1" x 1" FR4 board with minimum copper, t = 5 s
c. Refer to IPC / JEDEC® (J-STD-020), no manual or hand soldering
d. Maximum under steady state conditions is 135 °C/W
e. Maximum under steady state conditions is 400 °C/W
f. Package limited

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SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = -250 µA	-20	-	-	V
V_{DS} temperature coefficient	$\Delta V_{DS}/T_J$	I_D = -250 µA	-	-12.4	-	mV/°C
$V_{GS(th)}$ temperature coefficient	$\Delta V_{GS(th)}/T_J$		-	1.6	-	
Gate-source threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250 µA	-0.4	-	-0.9	V
Gate-source leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 4.5 V	-	-	± 0.5	µA
		V_{DS} = 0 V, V_{GS} = ± 8 V	-	-	± 7	
Zero gate voltage drain current	I_{DSS}	V_{DS} = -20 V, V_{GS} = 0 V	-	-	-1	µA
		V_{DS} = -20 V, V_{GS} = 0 V, T_J = 55 °C	-	-	-10	
On-state drain current [a]	$I_{D(on)}$	$V_{DS} \leq$ -5 V, V_{GS} = 0 V	-0.5	-	-	A
Drain-source on-state resistance [a]	$R_{DS(on)}$	V_{GS} = -4.5 V, I_D = -0.3 A	-	1.01	1.25	Ω
		V_{GS} = -2.5 V, I_D = -0.1 A	-	1.4	1.7	
		V_{GS} = -1.8 V, I_D = -0.1 A	-	2.1	2.7	
		V_{GS} = -1.5 V, I_D = -0.05 A	-	2.8	4.4	
Forward transconductance [a]	g_{fs}	V_{DS} = -10 V, I_D = -0.3 A	-	0.6	-	S
Dynamic [b]						
Input capacitance	C_{iss}	V_{DS} = -10 V, V_{GS} = 0 V, f = 1 MHz	-	31	-	pF
Output capacitance	C_{oss}		-	8.1	-	
Reverse transfer capacitance	C_{rss}		-	7	-	
Total gate charge	Q_g	V_{DS} = -10 V, V_{GS} = -8 V, I_D = -0.3 A	-	1.1	1.7	nC
		V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -0.3 A	-	0.64	1	
Gate-source charge	Q_{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_D = -0.3 A	-	0.13	-	
Gate-drain charge	Q_{gd}		-	0.1	-	
Gate resistance	R_g	f = xx MHz	15	74	150	Ω
Turn-on delay time	$t_{d(on)}$	V_{DD} = -10 V, R_L = 33.3 Ω, $I_D \cong$ -0.3 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	7	15	ns
Rise time	t_r		-	21	40	
Turn-off delay time	$t_{d(off)}$		-	11	20	
Fall time	t_f		-	11	20	
Turn-on delay time	$t_{d(on)}$	V_{DD} = -10 V, R_L = 33.3 Ω, $I_D \cong$ -0.3 A, V_{GEN} = -8 V, R_g = 1 Ω	-	2	5	
Rise time	t_r		-	18	40	
Turn-off delay time	$t_{d(off)}$		-	10	20	
Fall time	t_f		-	10	20	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I_S	T_A = 25 °C	-	-	-0.5 [c]	A
Pulse diode forward current	I_{SM}		-	-	-0.8	
Body diode voltage	V_{SD}	I_S = -0.3 A, V_{GS} = 0 V	-	-0.9	-1.2	V
Body diode reverse recovery time	t_{rr}	I_F = -0.3 A, di/dt = 100 A/µs, T_J = 25 °C	-	15	30	ns
Body diode reverse recovery charge	Q_{rr}		-	7.5	15	nC
Reverse recovery fall time	t_a		-	10.5	-	ns
Reverse recovery rise time	t_b		-	4.5	-	

Notes

a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %

b. Guaranteed by design, not subject to production testing

c. Surface mounted on 1" x 1" FR4 board with full copper, t = 5 s

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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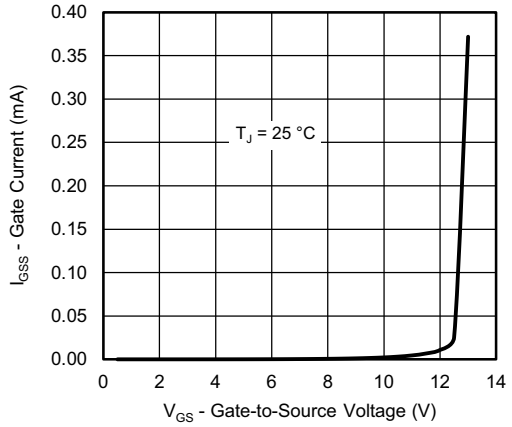
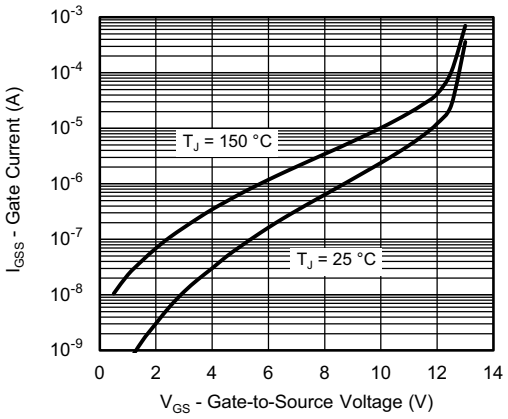
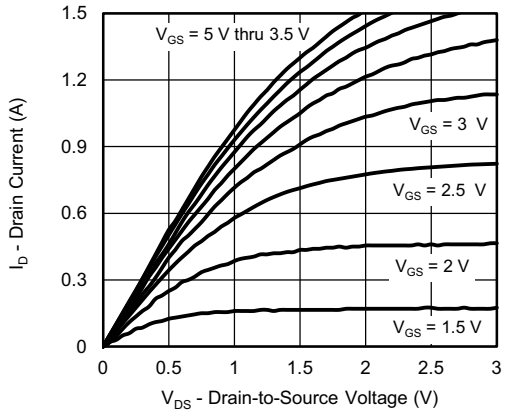


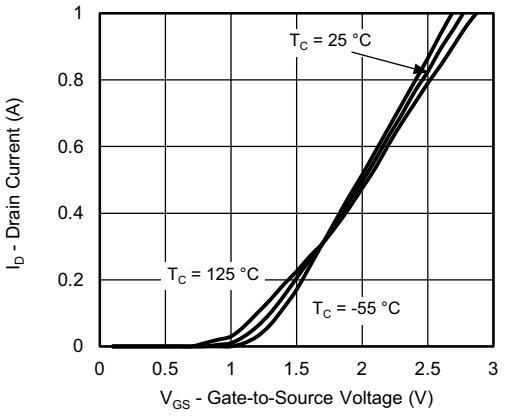
Gate Current vs. Gate-Source Voltage



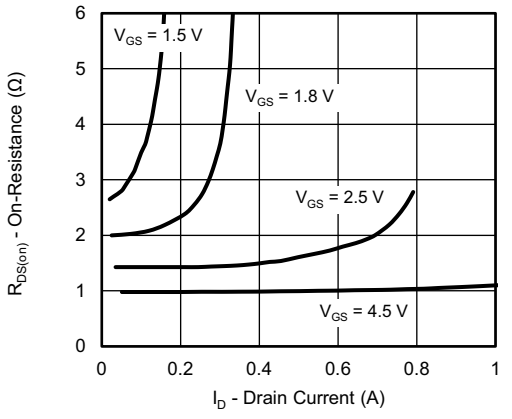
Gate Current vs. Gate-Source Voltage



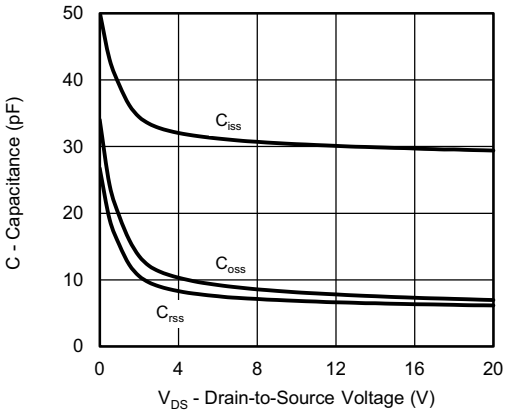
Output Characteristics



Transfer Characteristics



On-Resistance vs. Drain Current and Gate Voltage



Capacitance

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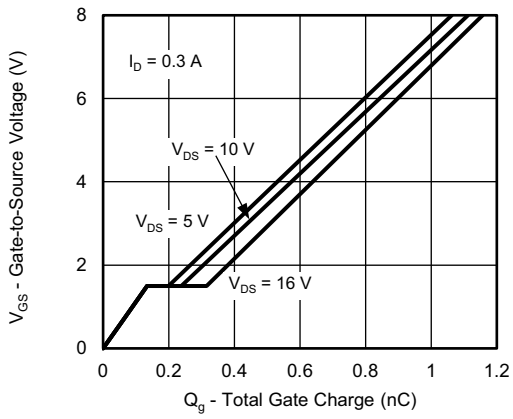
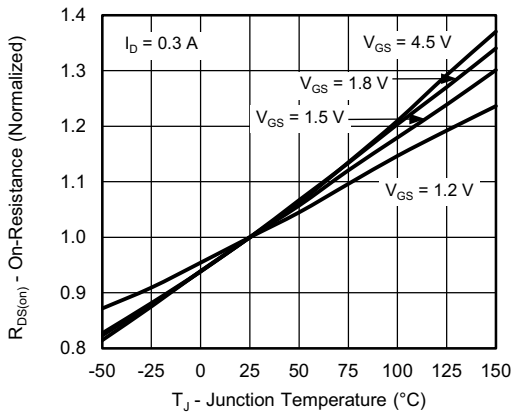
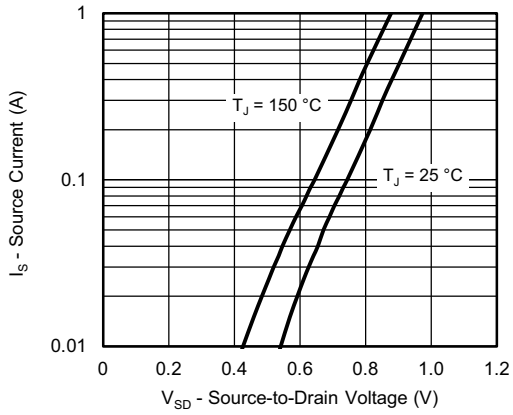


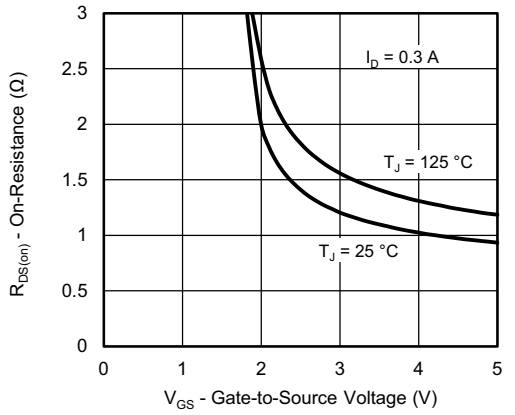
Gate Charge



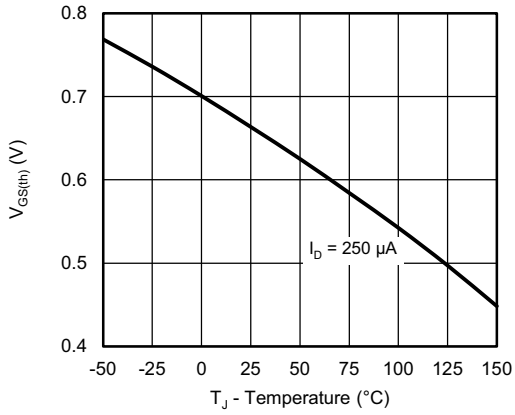
On-Resistance vs. Junction Temperature



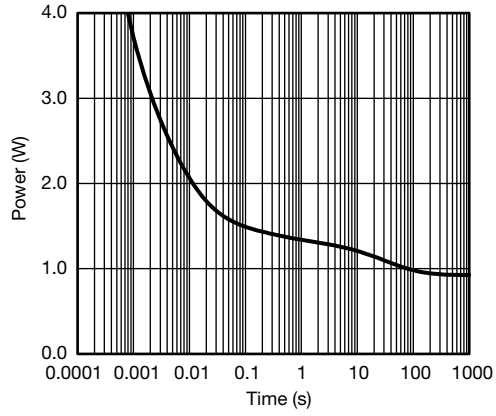
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power, Junction-to-Ambient

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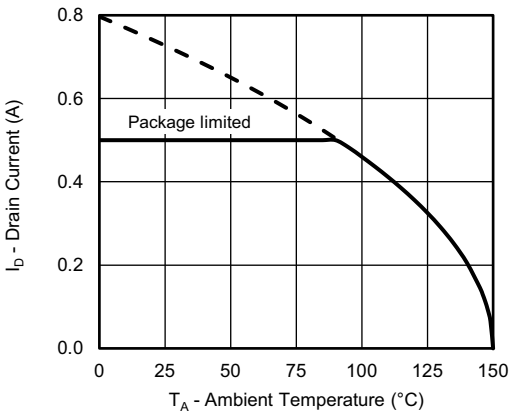
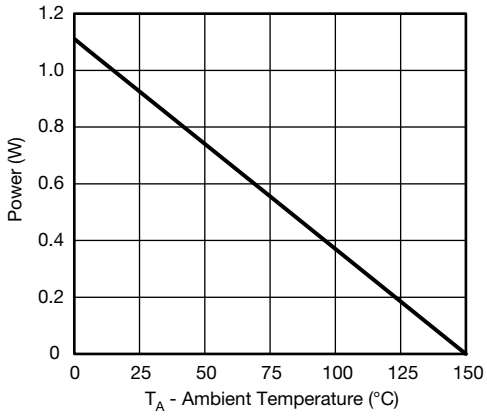
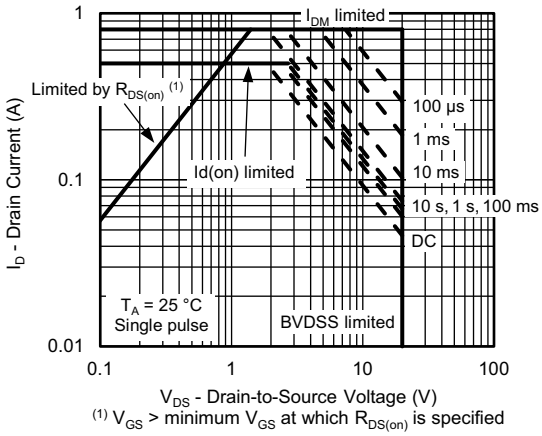


Current Derating [a]



Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

Note

a. The power dissipation P_D is based on T_J max. = 25 °C, using junction-to-ambient thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

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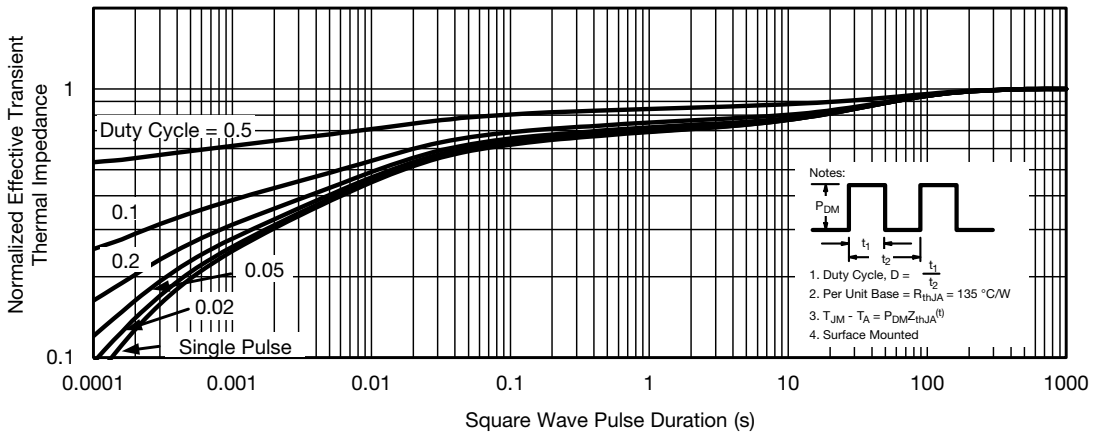
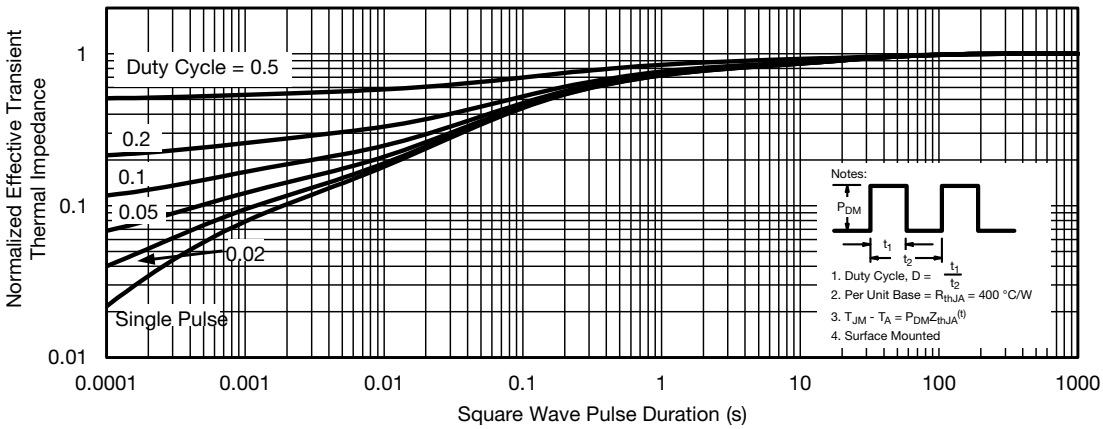


Normalized Thermal Transient Impedance, Junction-to-Ambient (on 1" x 1" FR4 board with maximum copper)



Normalized Thermal Transient Impedance, Junction-to-Ambient (on 1" x 1" FR4 board with minimum copper)

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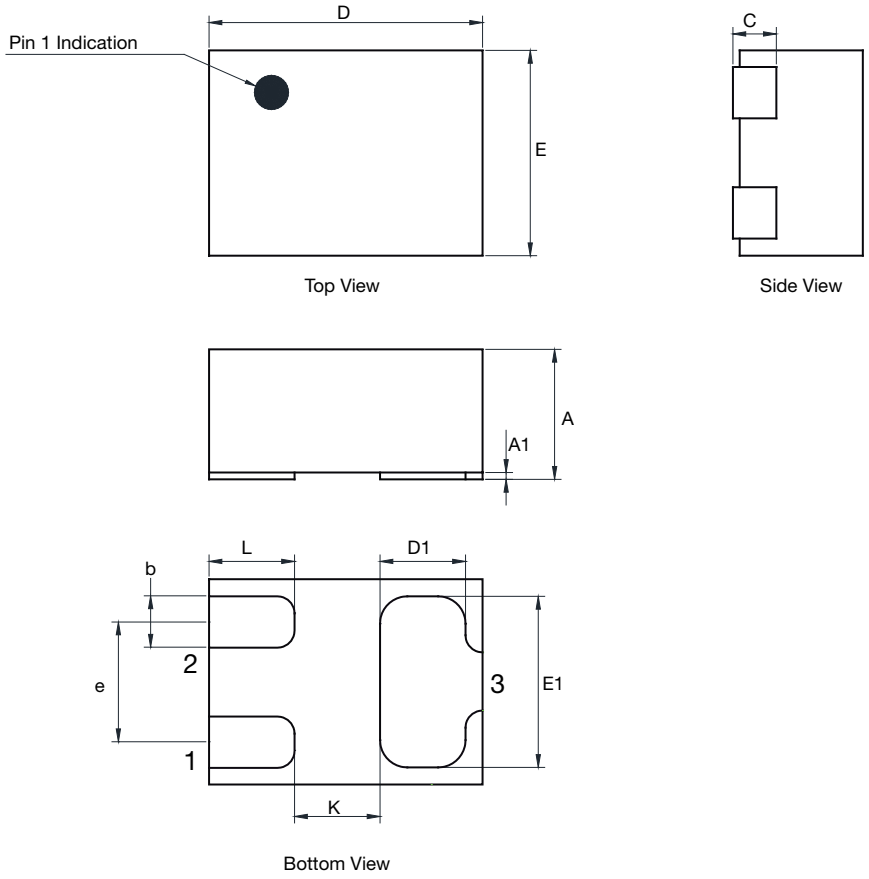
Case Outline for PowerPAK 0.8 mm x 0.6 mm



DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.350	0.380	0.400	0.0138	0.0150	0.0157
A1	0	-	0.020	0	-	0.0008
b	0.120	0.150	0.180	0.0047	0.0059	0.0071
C	0.119	0.127	0.135	0.0047	0.0050	0.0053
D	0.750	0.800	0.850	0.0295	0.0315	0.0335
D1	0.200	0.250	0.300	0.0078	0.0098	0.0118
E	0.550	0.600	0.650	0.0217	0.0236	0.0256
E1	0.450	0.500	0.550	0.0177	0.0197	0.0217
e	0.300	0.350	0.400	0.0118	0.0138	0.0158
K	0.150	0.250	0.350	0.0058	0.0098	0.0138
L	0.200	0.250	0.300	0.0078	0.0098	0.0118
ECN: C13-1574-Rev. A, 23-Dec-13 DWG: 6020						

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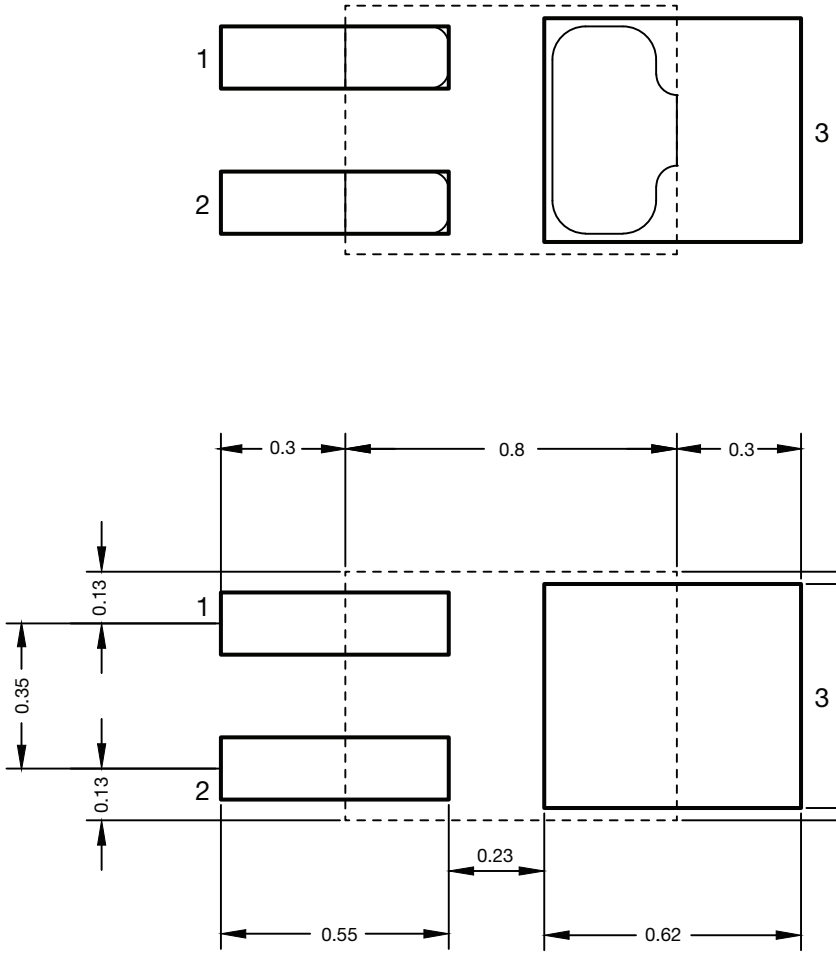
Recommended Land Pattern PowerPAK® 0806



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